

MOS FIELD EFFECT TRANSISTOR 2SK3404

SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

DESCRIPTION

The 2SK3404 is N-Channel MOS FET device that features a low on-state resistance and excellent switching characteristics, designed for low voltage high current applications such as DC/DC converter with synchronous rectifier.

ORDERING INFORMATION

PART NUMBER	PACKAGE			
2SK3404	TO-220AB			
2SK3404-ZK	TO-263(MP-25ZK)			
2SK3404-ZJ	TO-263(MP-25ZJ)			

FEATURES

- 4.5-V drive available
- Low on-state resistance $R_{DS(on)1} = 14 \ m\Omega \ MAX. \ (V_{GS} = 10 \ V, \ I_D = 20 \ A)$
- Low gate charge
 Q_G = 25 nC TYP. (I_D = 40 A, V_{DD} = 24 V, V_{GS} = 10 V)
- Built-in gate protection diode
- Surface mount device available

ABSOLUTE MAXIMUM RATINGS (TA = 25°C)

Drain to Source Voltage (Vgs = 0 V)	Vdss	30	V
Gate to Source Voltage ($V_{DS} = 0 V$)	Vgss	±20	V
Drain Current (DC) (Tc = 25°C)	ID(DC)	±40	А
Drain Current (Pulse) Note	D(pulse)	±160	А
Total Power Dissipation (T _A = 25°C)	P _{T1}	1.5	W
Total Power Dissipation (Tc = 25°C)	P _{T2}	40	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg	-55 to +150	°C

Note PW \leq 10 μ s, Duty Cycle \leq 1%

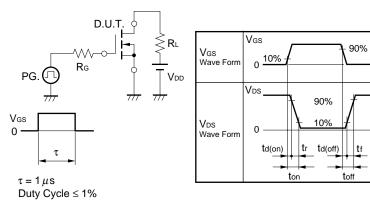
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Document No. D14638EJ2V0DS00 (2nd edition) Date Published May 2001 NS CP(K) Printed in Japan The mark \star shows major revised points.

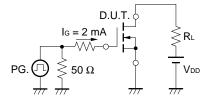
ELECTRICAL CHARACTERISTICS(TA = 25°C)

CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Drain Leakage Current	loss	Vds = 30 V, Vgs = 0 V			10	μA
Gate Leakage Current	lgss	$V_{GS} = \pm 20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$			±10	μA
Gate to Source Cut-off Voltage	VGS(off)	V _{DS} = 10 V, I _D = 1 mA	1.5		2.5	V
Forward Transfer Admittance	y _{fs}	V _{DS} = 10 V, I _D = 20 A	8.0			S
Drain to Source On-state Resistance	RDS(on)1	Vgs = 10 V, Id = 20 A		11	14	mΩ
	RDS(on)2	Vgs = 4.5 V, Id = 20 A		15	21	mΩ
Input Capacitance	Ciss	V _{DS} = 10 V		1400		pF
Output Capacitance	Coss	Vgs = 0 V		410		pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		180		pF
Turn-on Delay Time	td(on)	Vdd = 15 V , Id = 20 A		20		ns
Rise Time	tr	$V_{GS(on)} = 10 V$		9		ns
Turn-off Delay Time	td(off)	R _G = 10 Ω		50		ns
Fall Time	tr			14		ns
Total Gate Charge	QG	V _{DD} = 24 V		25		nC
Gate to Source Charge	Q _{GS}	Vgs = 10 V		5.0		nC
Gate to Drain Charge	Qgd	ID = 40 A		7.0		nC
Diode Forward Voltage	VF(S-D)	IF = 40 A, VGS = 0 V		1.0		V
Reverse Recovery Time	trr	IF = 40 A, VGS = 0 V		31		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A/µs		28		nC

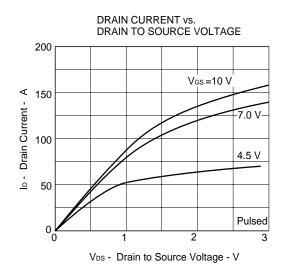
TEST CIRCUIT 1 SWITCHING TIME



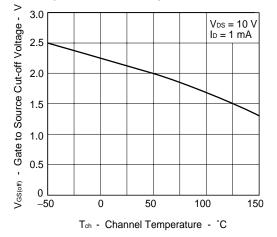
TEST CIRCUIT 2 GATE CHARGE

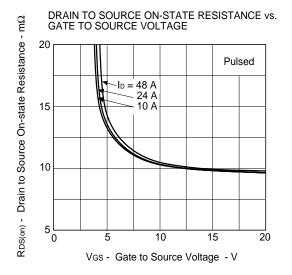


TYPICAL CHARACTERISTICS (TA = 25°C)

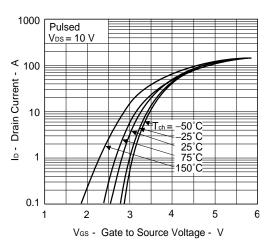




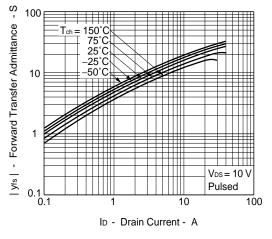


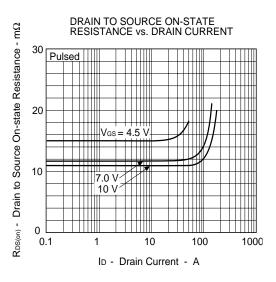


FORWARD TRANSFER CHARACTERISTICS

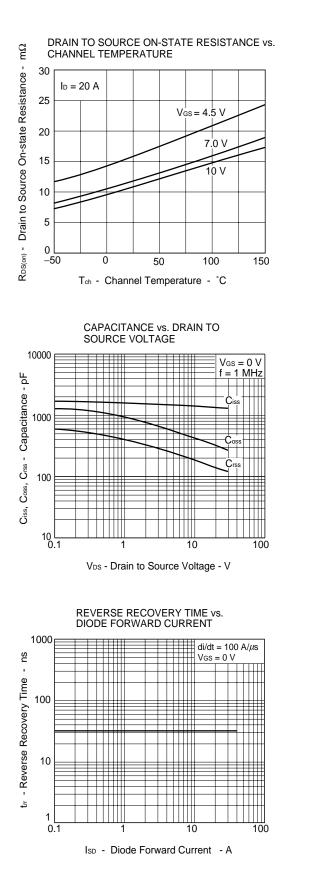


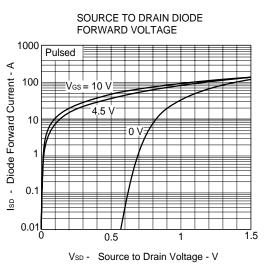
FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



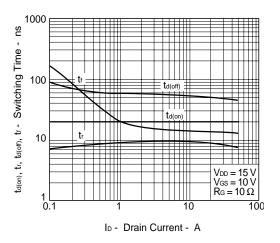


Data Sheet D14638EJ2V0DS

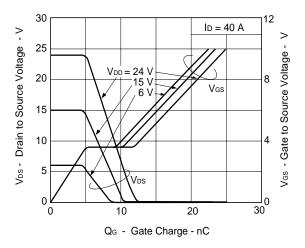




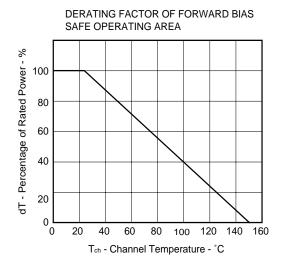
SWITCHING CHARACTERISTICS



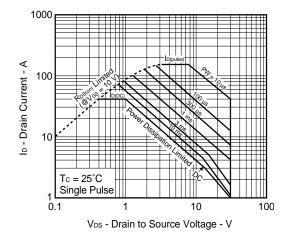
DYNAMIC INPUT/OUTPUT CHARACTERISTICS

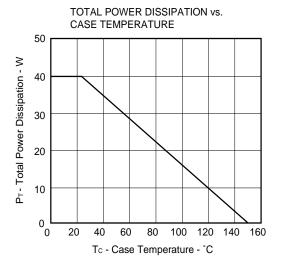


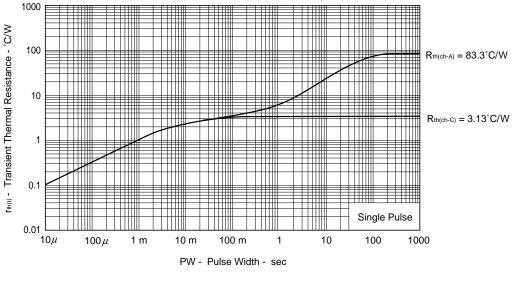
Data Sheet D14638EJ2V0DS



FORWARD BIAS SAFE OPERATING AREA





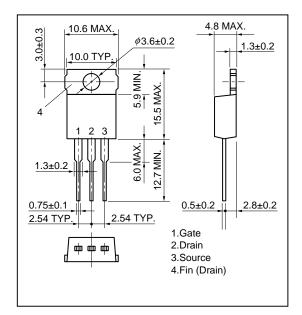


TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH

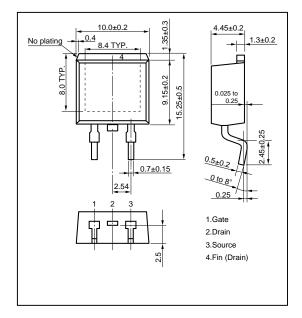
Data Sheet D14638EJ2V0DS

PACKAGE DRAWINGS (Unit : mm)

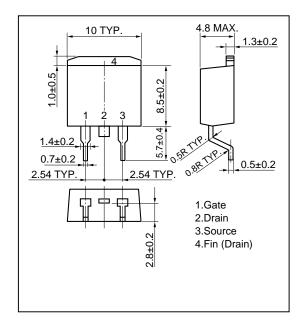
* 1)TO-220AB (MP-25)



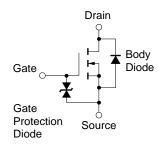
2)TO-263 (MP-25ZK)



* 3)TO-263 (MP-25ZJ)



EQUIVALENT CIRCUIT



Remark The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device. [MEMO]

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